

Description

The TD817 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar phototransistor detector in a plastic DIP4 package with different lead forming options.

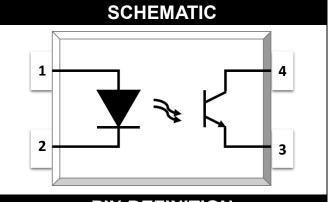
With the robust coplanar double mold structure, TD817 series provide the most stable isolation feature.

Features

- High isolation 5000 VRMS
- CTR flexibility available see order information
- DC input with transistor output
- Operating temperature range 55 °C to 110 °C
- REACH compliance
- Halogen free
- MSL class 1
- Regulatory Approvals
 - UL UL1577
 - VDE EN60747-5-5(VDE0884-5)
 - CQC GB4943.1, GB8898

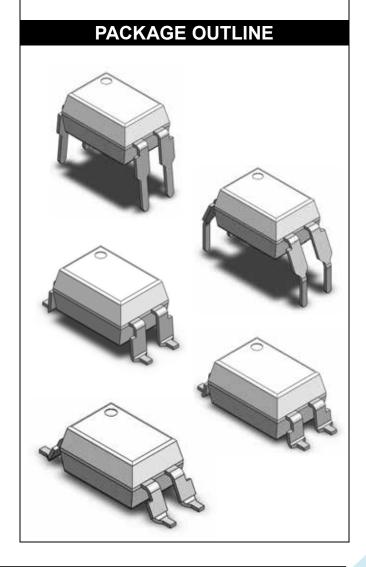
Applications

- Switch mode power supplies
- Programmable controllers
- Household appliances
- Office equipment



PIN DEFINITION

- 1. Anode
- 2. Cathode
- 3. Emitter
- 4. Collector





ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	VALUE	UNIT	NOTE		
INPUT						
Forward Current	lf	60	mA			
Peak Forward Current	IFP	1	Α	1		
Reverse Voltage	VR	6	V			
Input Power Dissipation	Pı	100	mW			
OUTPUT						
Collector - Emitter Voltage	VCEO	35	V			
Emitter - Collector Voltage	VECO	7	V			
Collector Current	Ic	50	mA			
Output Power Dissipation	Po	150	mW			
COMMON						
Total Power Dissipation	Ptot	200	mW			
Isolation Voltage	Viso	5000	Vrms	2		
Operating Temperature	Topr	-55~110	C			
Storage Temperature	Tstg	-55~125	C			
Soldering Temperature	Tsol	260	C			

Note 1. 100μs pulse, 100Hz frequency

Note 2. AC For 1 Minute, R.H. = $40 \sim 60\%$

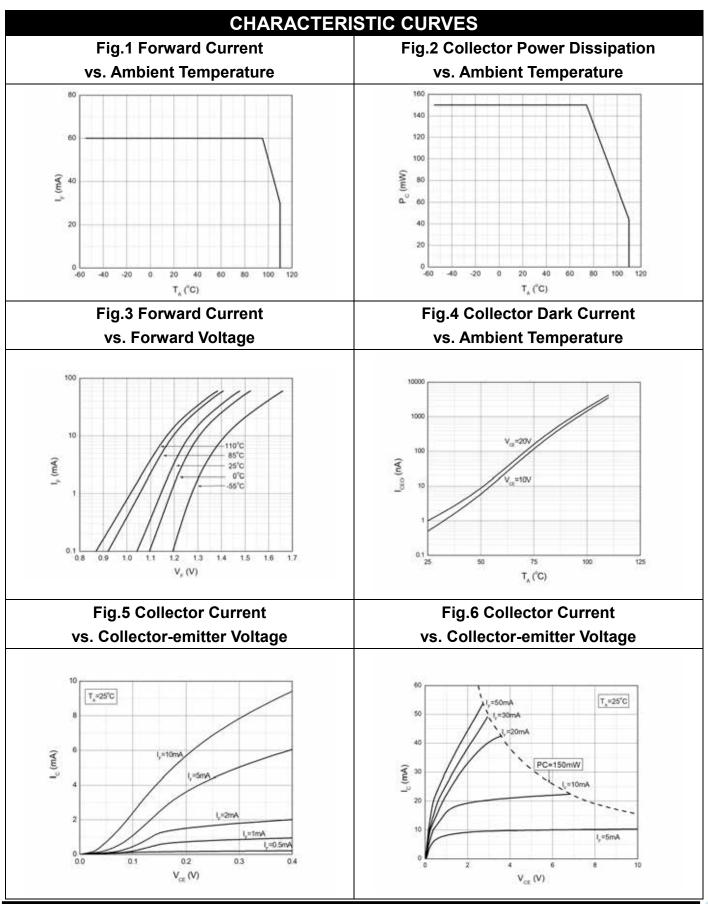


ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C									
PARAMI	ETER	SYMBOL	MIN	TYP.	P. MAX. UNIT		TEST CONDITION	NOTE	
INPUT									
Forward \	/oltage	VF	-	1.24	1.4	V	IF=10mA		
Reverse (Reverse Current		-	-	10	μA	VR=6V		
Input Capa	Input Capacitance		-	10	-	- pF V=0, f=1kHz			
				OUT	PUT				
Collector Da	rk Current	ICEO	-	-	100	nA	VCE=20V, IF=0		
Collector- Breakdown		BVCEO	35	-	-	٧	IC=0.1mA, IF=0		
Emitter-Co Breakdown		BV _{ECO}	7	-	-	٧	IE=0.1mA, IF=0		
TRANSFER CHARACTERISTICS									
	TD817	CTR	50	-	600	- %			
Current	TD817A		80	-	160				
Current Transfer	TD817B		130	-	260		IF=5mA, VCE=5V		
Ratio	TD817C		200	-	400		/0 IF-SIIIA, VOE-SV	IF-SIIIA, VOE-SV	
Rallo	TD817D		300	-	600				
	TD817E		100	-	200				
Collector-Emitter		V _{CE(sat)}		0.06	0.2	\ \	IF=20mA, IC=1mA		
Saturation Voltage		V CE(sat)	-	- 0.06 0.2	0.2 V	II -20IIIA, IO-IIIIA			
Isolation Resistance		Riso	10^12	10^14	-	Ω	DC500V, 40 ~ 60% R.H.		
Floating Capacitance		C _{IO}	-	0.4	1	pF	V=0, f=1MHz		
Cut off Fraguency		fc	fc -	80	0 -	- kHz	VCE=2V, IC=2mA	3	
Gut-on 1-16	Cut-off Frequency		_			KI IZ	RL=100Ω,-3dB	J	
Response Ti	me (Rise)	tr	-	3	18	μs	VCE=2V, IC=2mA	4	
Response T	Response Time (Fall)		-	4	18	μs	RL=100Ω	4	

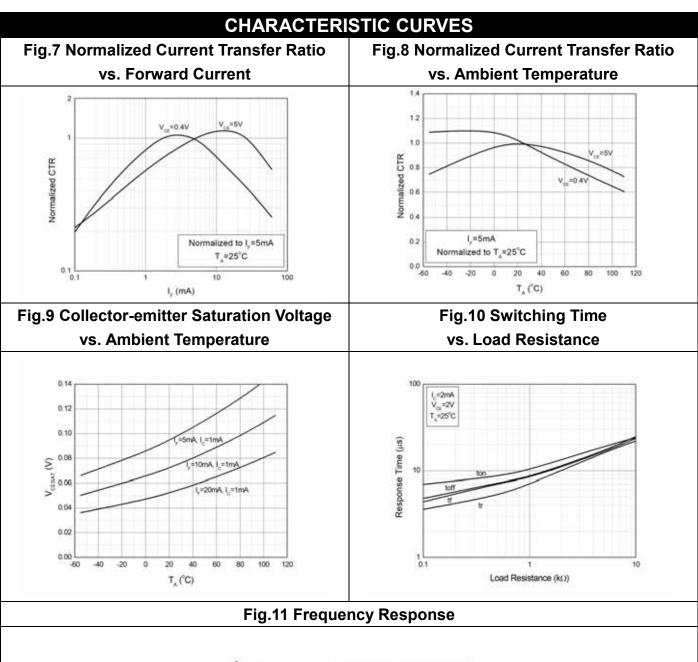
Note 3. Fig.12&13

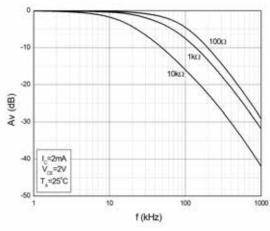
Note 4. Fig.14



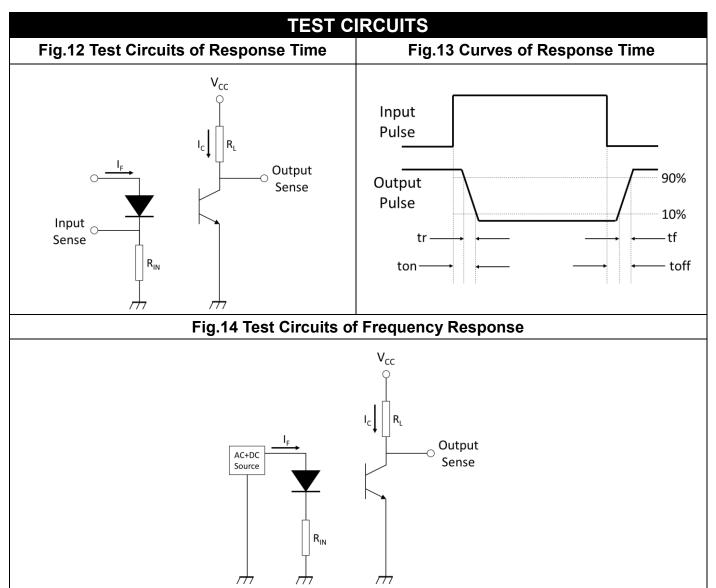




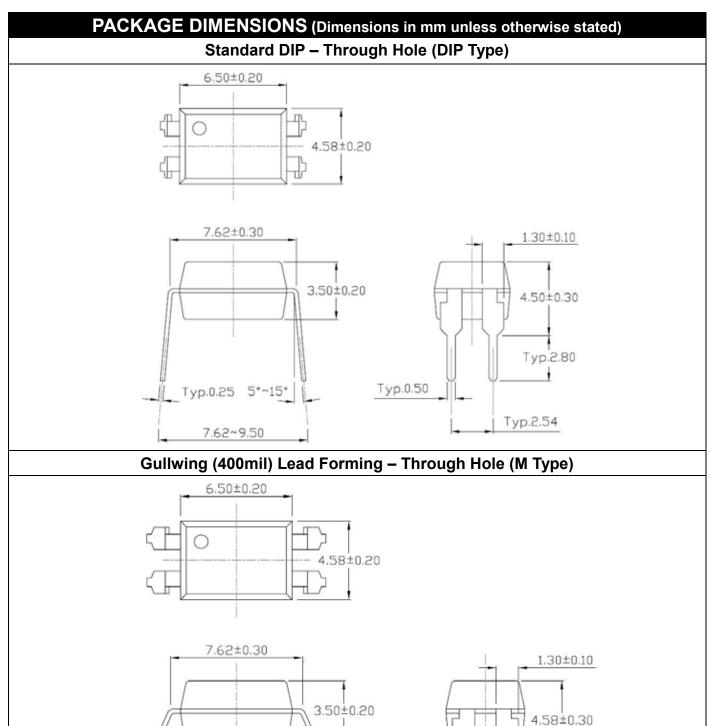












Typ.0.50

Document No:DWI-001 Rev: A02 Release Date: 2020/3/9

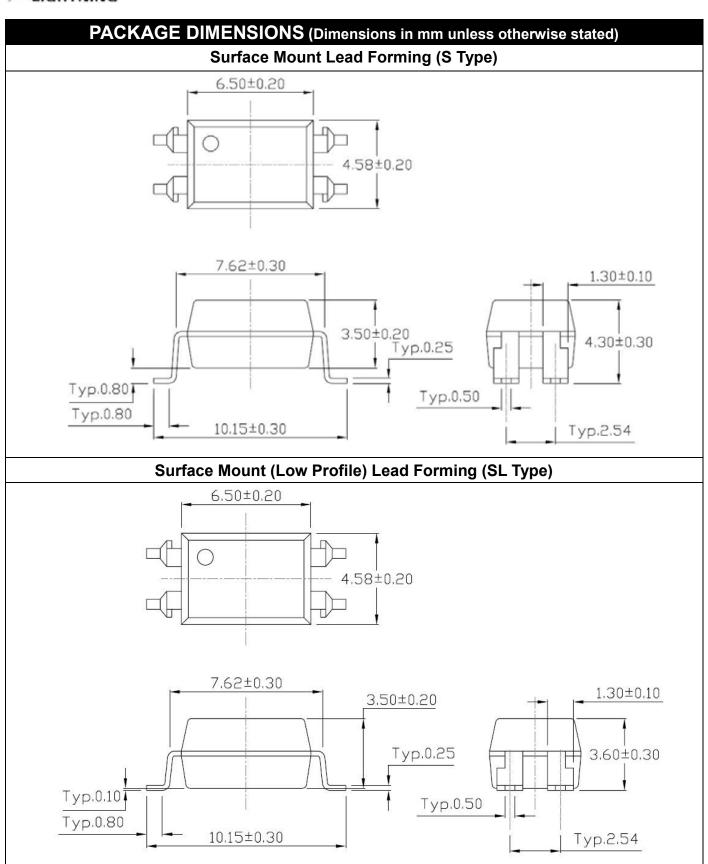
Typ.0.25

10.16±0.30

Typ.2.20

Typ.2.54





Typ.2.54



0.60Min.

DIP4, DC Input, Photo Transistor Coupler

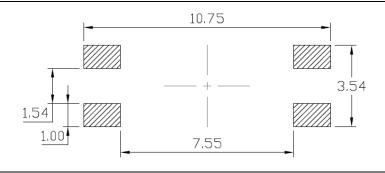
PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated) Surface Mount (Gullwing) Lead Forming (SLM Type) 6.50±0.20 7.62±0.30 7.62±0.30 7.62±0.30 7.62±0.30 7.62±0.30 7.62±0.30 7.62±0.30

RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated)

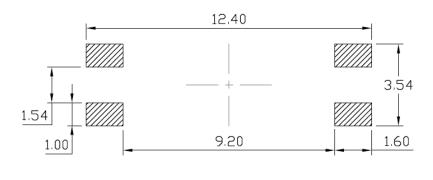
10.16±0.30

11.80±0.30

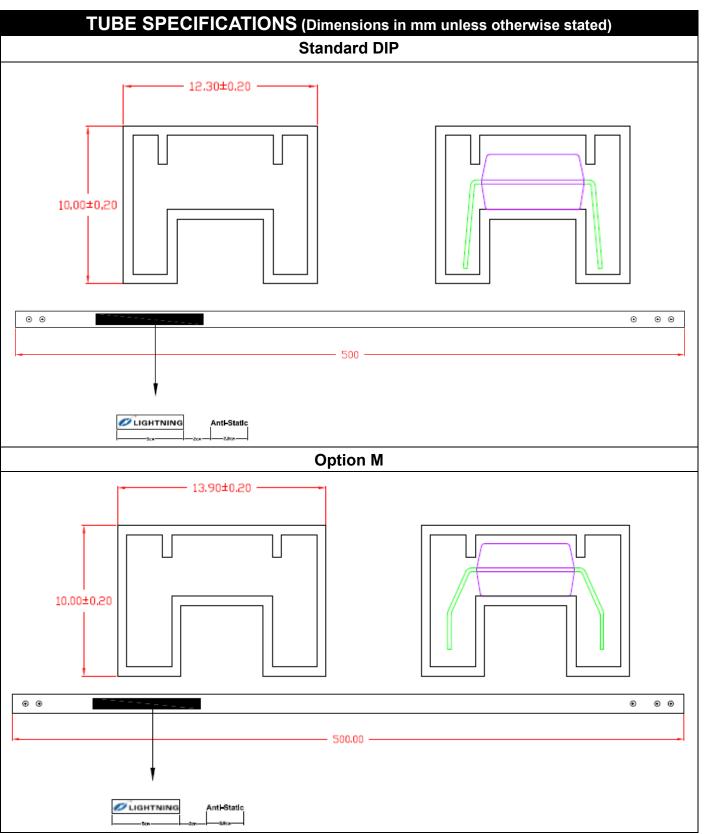
Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming



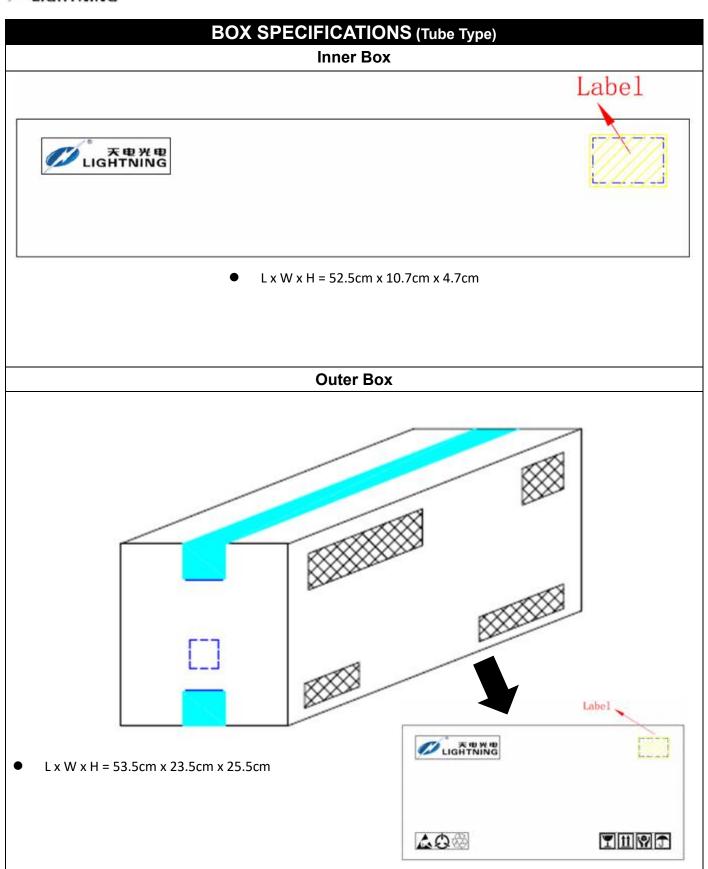
Surface Mount (Gullwing) Lead Forming







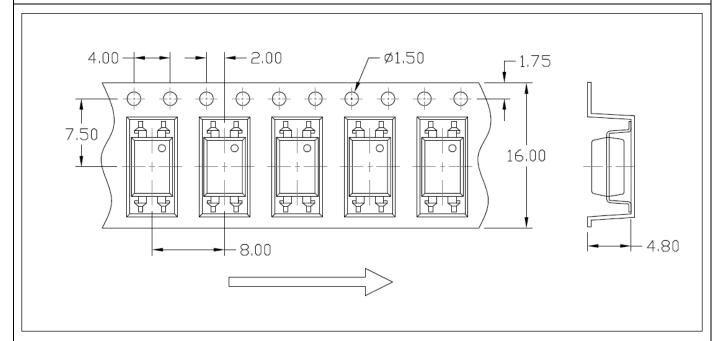




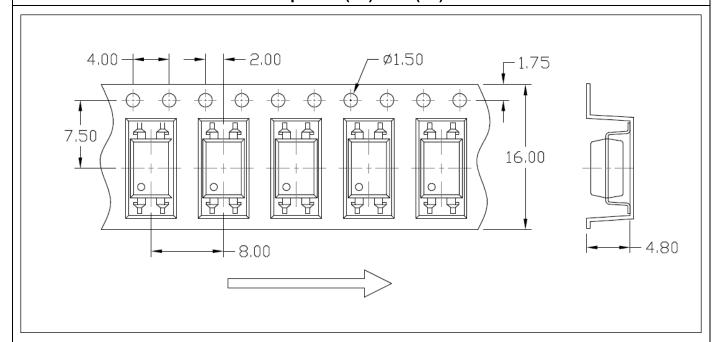


CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option S(T1) & SL(T1)



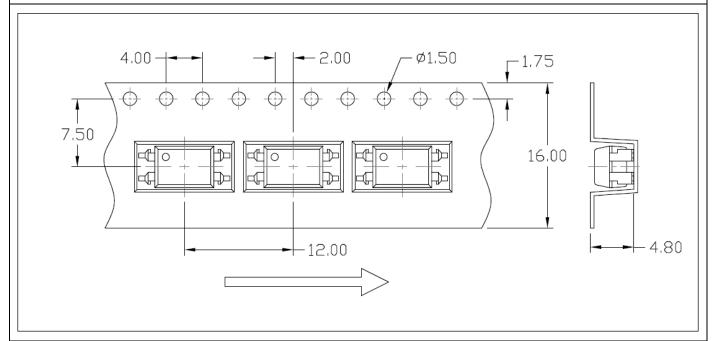
Option S(T2) & SL(T2)



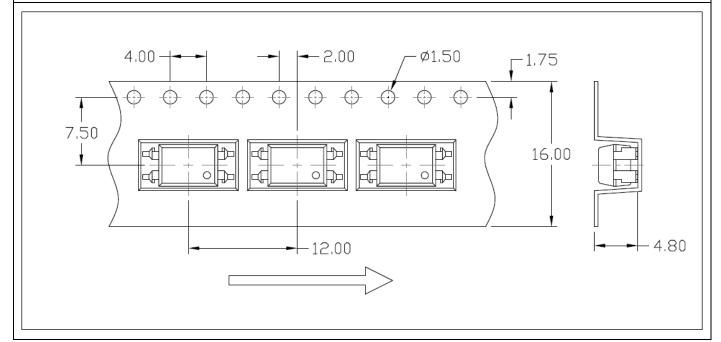


CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option S(T3) & SL(T3)

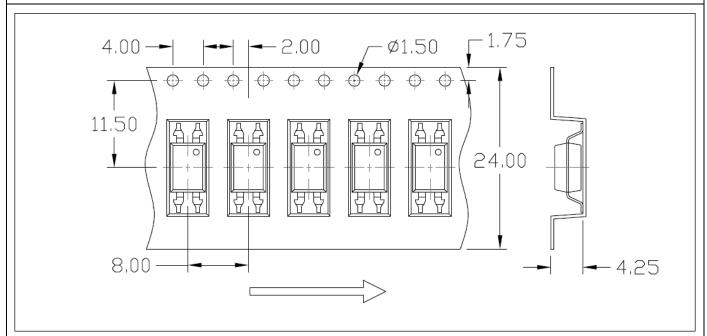


Option S(T4) & SL(T4)

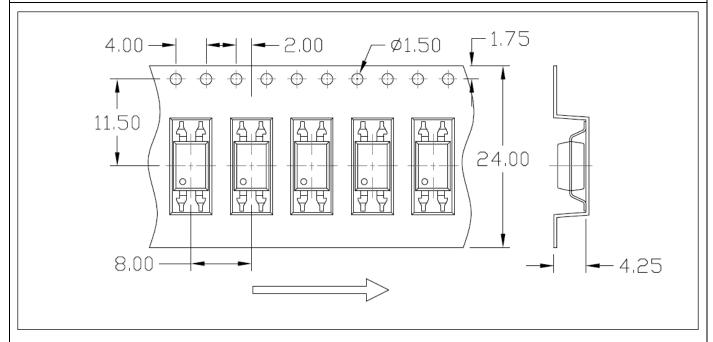




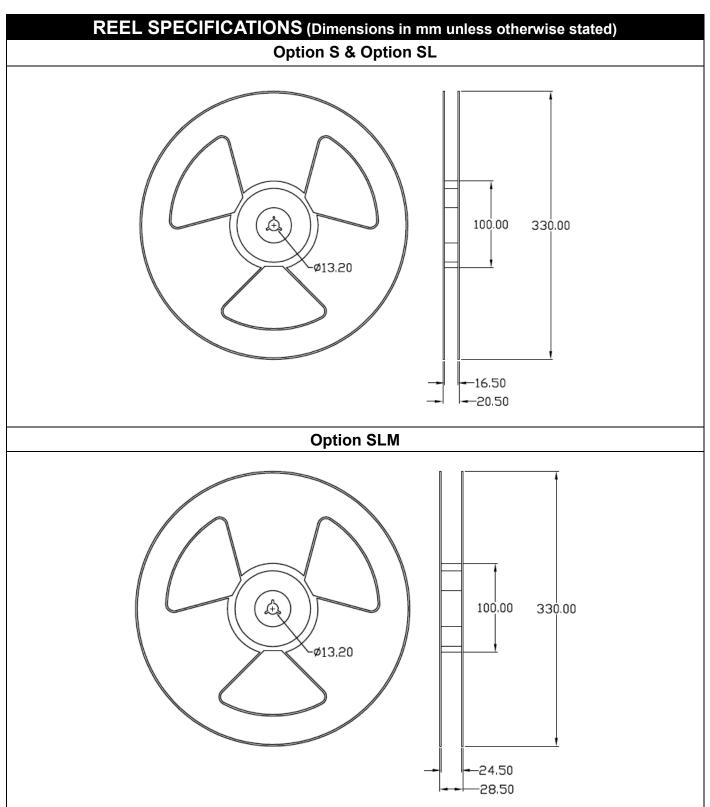
CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated) Option SLM(T1)



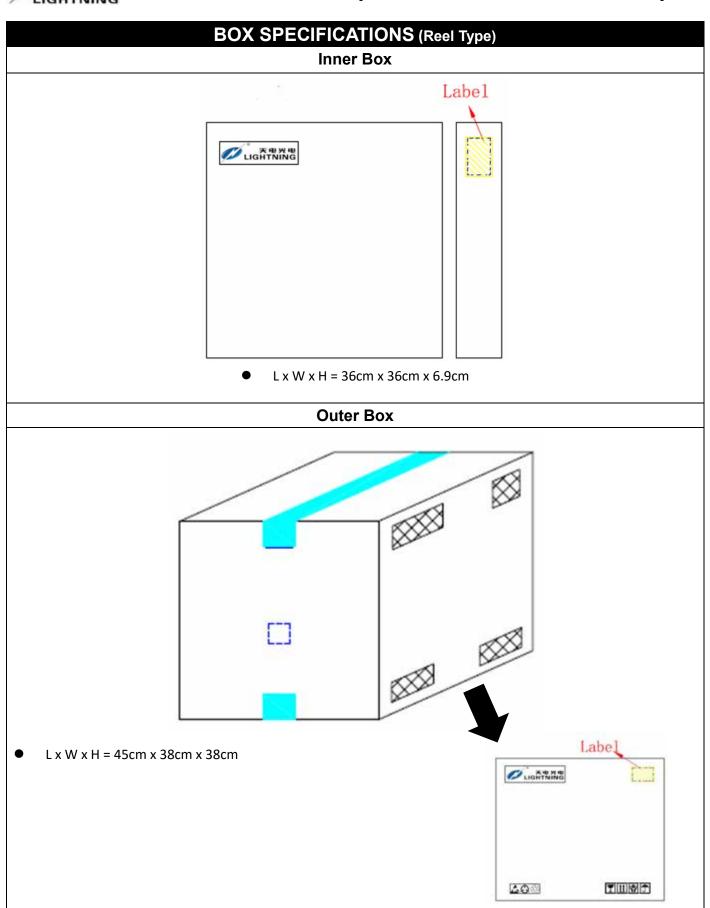
Option SLM(T2)













ORDERING AND MARKING INFORMATION

MARKING INFORMATION



TD : Company Abbr. F : Leadframe Option

817 : Part Number

X : CTR Rank

V : VDE Option

Υ : Fiscal Year

: Manufacturing Code

ww : Work Week

ORDERING INFORMATION

TD817X(Y)(Z)-FGV

TD - Company Abbr.

817 - Part Number

X – Rank (A/B/C/D/E or None)

Y – Lead Form Option (M/S/SL/SLM/None)

Z – Tape and Reel Option (T1/T2/T3/T4)

F – Leadframe Option (F:Iron, None:Copper)

G - Green

V – VDE Option (V or None)

福建天电光电有限公司 FUJIAN LIGHTNING OPTOELECTRONIC CO., LTD. Part No: XXXXXXXXXXXXXX Lot No: XXXXXXXXXX Date Code: XXXX Q'ty: XXXX pcs

LABEL INFORMATION

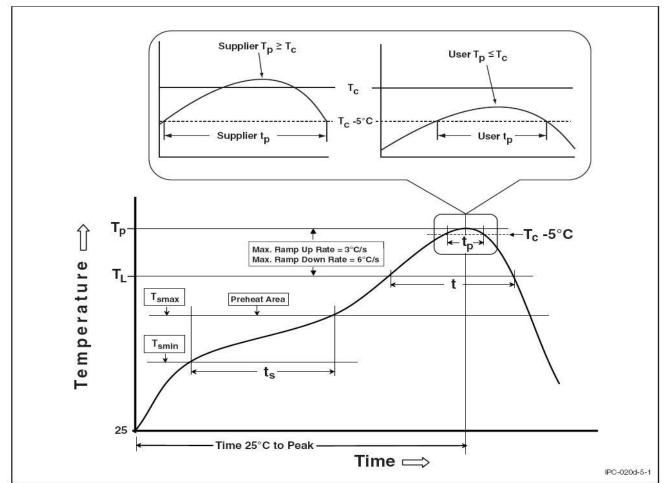


Packing Quantity

. doming quantity					
Option	Quantity	Quantity – Inner box	Quantity – Outer box		
None	100 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 32k Units		
М	100 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 32k Units		
S(T1)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units		
S(T2)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units		
S(T3)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units		
S(T4)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units		
SL(T1)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units		
SL(T2)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units		
SL(T3)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units		
SL(T4)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units		
SLM(T1)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units		
SLM(T2)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units		

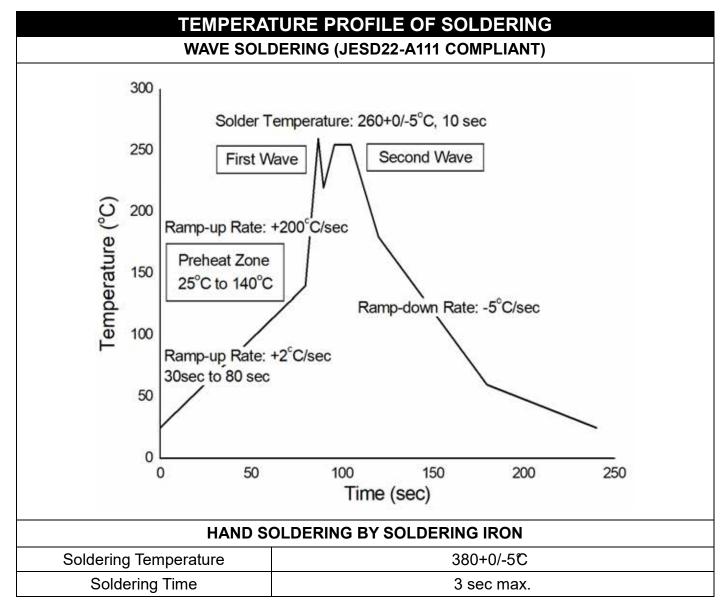


REFLOW INFORMATION REFLOW PROFILE



Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100	150°C
Temperature Max. (Tsmax)	150	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.
Liquidous Temperature (TL)	183℃	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.





- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.



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- Please contact LIGHTNING sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
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- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.